Electronic Patent Application Fee Transmittal							
Application Number:	10589883						
Filing Date:	18-Aug-2006						
Title of Invention:	Composite moldings and a method of manufacturing the same						
First Named Inventor/Applicant Name:	Katsuhide Ohashi						
Filer:	Isaac R. Clark Jr./Heidi Kim						
Attorney Docket Number:	056208.58072US						
Filed as Large Entity							
U.S. National Stage under 35 USC 371 Filing Fees							
Description		Fee Code	Quantity	Amount	Sub-Total in USD(\$)		
Basic Filing:							
Pages:							
Claims:							
Claims in excess of 20		1615	3	52	156		
Independent claims in excess of 3		1614	3	220	660		
Miscellaneous-Filing:							
Petition:							
Patent-Appeals-and-Interference:							
Post-Allowance-and-Post-Issuance:							

Description	Fee Code	Quantity	Amount	Sub-Total in USD(\$)
Extension-of-Time:				
Extension - 2 months with \$0 paid	1252	1	490	490
Miscellaneous:				
	Tot	1306		